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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant:

Young-Joon Park, et al.

Docket Number: TI-35623

Serial No.: 10/628,198

Art Unit: 2814

Filed: 07/28/03

Examiner: Ginette Peralta

For:

A Two-Step Semiconductor Manufacturing Process for

Copper Interconnects

CERTIFICATION OF FACSIMILE TRANSMISSION

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FACSIMILE COVER SHEET

X FACSIMILE COVER SHEET NEW APPLICATION DECLARATION ASSIGNMENT FORMAL DRAWINGS INFORMAL DRAWINGS CONTINUATION APP'N DIVISIONAL APP'N		X AMENDMENT 111 (12 pages) EOT
NAME OF INVENTOR(S):		RECEIPT DATE & SERIAL NO.:
Young-Joon Park, et al.		Serial No.: 10/628,198
TITLE OF INVENTION: A Two-Step		Filing Date: 07/28/03
Semiconductor Manufacturing Process		
for Copper Interconnects		
TI FILE NO.:	DEPOSIT ACCT. NO.:	
TI-35623	20-0668	
FAXED: 12-22-05 DUE: 1-5-06 ATTY/SEC'Y: RAK/kjv		

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Texas Instruments Incorporated PO Box 655474, M/S 3999 Dallas, TX 75265-5474

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Park et al.

Docket No.: TI-35623

Serial No.: 10/628,198

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Examiner: Peralta, Ginette

Title: A Two-Step Semiconductor Manufacturing Process for Copper

Interconnects

AMENDMENT UNDER 37 C.F.R. §1.111

December 22, 2005

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

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Dear Commissioner:

In response to the Office Action, dated 10/05/2005, in the above-identified patent application, please make the following amendments. They are respectfully submitted as a full and complete response to that Action. Please charge any required fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.